

SCES641-MAY 2007

FEATURES

- Available in the Texas Instruments
 NanoFree™ Packages
- 1.2 V to 3.6 V on A Port and 1.65 V to 5.5 V on B Port (V_{CCA} ≤ V_{CCB})
- V_{CC} Isolation Feature If Either V_{CC} Input Is at GND, All Outputs Are in the High-Impedance State
- OE Input Circuit Referenced to V_{CCA}
- Low Power Consumption, 4-μA Max I_{CC}
- I_{off} Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - A Port
 - 2500-V Human-Body Model (A114-B)
 - 200-V Machine Model (A115-A)
 - 1500-V Charged-Device Model (C101)
 - B Port
 - 15-kV Human-Body Model (A114-B)
 - 200-V Machine Model (A115-A)
 - 1500-V Charged-Device Model (C101)

DCT OR DCU PACKAGE (TOP VIEW) B2 1 8 B1 GND 2 7 V_{CCB} 6 OE 5 A1

YZP PACKAGE (BOTTOM VIEW)

| A2 | 0450 | A1 |
|-------------------------|------------------------------|--------------|
| V_{CCA} | 0360 | OE |
| V _{CCA} GND | 0270 | V CCB |
| B2 | O450 O360 O270 O180 | B1 |
| | | _ |

DESCRIPTION/ORDERING INFORMATION

This 2-bit noninverting translator uses two separate configurable power-supply rails. The A port is designed to track V_{CCA} . V_{CCA} accepts any supply voltage from 1.2 V to 3.6 V. The B port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.65 V to 5.5 V. This allows for universal low-voltage bidirectional translation between any of the 1.2-V, 1.5-V, 1.8-V, 2.5-V, 3.3-V, and 5-V voltage nodes. V_{CCA} should not exceed V_{CCB} .

When the output-enable (OE) input is low, all outputs are placed in the high-impedance state.

This device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

To ensure the high-impedance state during power up or power down, OE should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

NanoFree™ package technology is a major breakthrough in IC packaging concepts, using the die as the package.

PDPlease be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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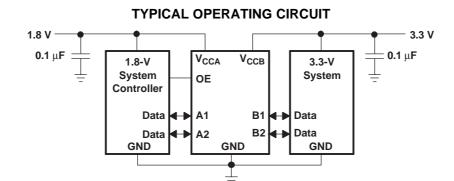
ORDERING INFORMATION

| T _A | PACKAGE ⁽¹⁾⁽²⁾ | | ORDERABLE PART NUMBER | TOP-SIDE MARKING(3) |
|----------------|---|--------------|-----------------------|---------------------|
| | NanoFree™ – WCSP (DSBGA) 0.23-mm Large Bump – YZP (Pb-free) | Reel of 3000 | TXB0102YZPR | 2E_ |
| -40°C to 85°C | SOT (SOT-23) – DCT | Reel of 3000 | | NED |
| | SOT (SOT-23) – DCT | Reel of 250 | TXB0102DCTT | NFD_ |
| | SOT (SOT 70) DOLL | Reel of 3000 | TXB0102DCUR | NFD |
| | SOT (SOT-70) – DCU | Reel of 250 | TXB0102DCUT | INFU_ |

- (1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.
- (2) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.
- (3) YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site. Pin 1 identifier indicates solder-bump composition (1 = SnPb, = Pb-free).

PIN DESCRIPTION

| PIN | NAME | FUNCTION |
|-----|------------------|--|
| 1 | B2 | Input/output B. Referenced to V _{CCB} . |
| 2 | GND | Ground |
| 3 | V_{CCA} | A port supply voltage. 1.2 V \leq V _{CCA} \leq 3.6 V and V _{CCA} \leq V _{CCB} |
| 4 | A2 | Input/output A. Referenced to V _{CCA} . |
| 5 | A1 | Input/output A. Referenced to V _{CCA} . |
| 6 | OE | 3-State output. Pull OE low to place all outputs in 3-state mode. Referenced to V _{CCA} . |
| 7 | V _{CCB} | B port supply voltage. 1.65 V \leq V _{CCB} \leq 5.5 V |
| 8 | B1 | Input/output B. Referenced to V _{CCB} . |





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Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | MAX | UNIT |
|------------------|---|--------------------|------|------------------------|------|
| V_{CCA} | Supply voltage range | | -0.5 | 4.6 | V |
| V_{CCB} | Supply voltage range | | -0.5 | 6.5 | V |
| V | Input voltage range (2) | A port | -0.5 | 4.6 | V |
| VI | Input voltage range (2) | B port | -0.5 | 6.5 | V |
| 1/ | Voltage range applied to any output in the high-impedance or | A port | -0.5 | 4.6 | V |
| Vo | power-off state ⁽²⁾ | B port | -0.5 | 6.5 | V |
| V | Voltage range applied to any output in the high or law state (2)(3) | A port | -0.5 | V _{CCA} + 0.5 | V |
| Vo | Voltage range applied to any output in the high or low state (2)(3) | B port | -0.5 | V _{CCB} + 0.5 | V |
| I _{IK} | Input clamp current | V _I < 0 | | - 50 | mA |
| I _{OK} | Output clamp current | V _O < 0 | | - 50 | mA |
| Io | Continuous output current | | | ±50 | mA |
| | Continuous current through V _{CCA} , V _{CCB} , or GND | | | ±100 | mA |
| | | DCT package | | 220 | |
| θ_{JA} | Package thermal impedance (4) | DCU package | | 227 | °C/W |
| | | YZP package | | 102 | |
| T _{stg} | Storage temperature range | | -65 | 150 | °C |

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
 (3) The value of V_{CCA} and V_{CCB} are provided in the recommended operating conditions table.
 (4) The package thermal impedance is calculated in accordance with JESD 51-7.

Recommended Operating Conditions (1)(2)

| | | | V _{CCA} | V _{CCB} | MIN | MAX | UNIT |
|-----------------|---|----------------|------------------|------------------|-----------------------------|-----------------------------|------|
| V_{CCA} | Cupply voltage | | | | 1.2 | 3.6 | V |
| V_{CCB} | Supply voltage | | | | 1.65 | 5.5 | V |
| V | High level input voltage | Data inputs | 1.2 V to 3.6 V | 1.65 V to 5.5 V | $V_{CCI} \times 0.65^{(3)}$ | V _{CCI} | V |
| V _{IH} | High-level input voltage | OE input | 1.2 V to 3.6 V | 1.65 V to 5.5 V | $V_{CCA} \times 0.65$ | 5.5 | V |
| V | Law layel input valtage | Data inputs | 1.2 V to 5.5 V | 1.65 V to 5.5 V | 0 | $V_{CCI} \times 0.35^{(3)}$ | V |
| V_{IL} | Low-level input voltage | OE input | 1.2 V to 3.6 V | 1.65 V to 5.5 V | 0 | $V_{CCA} \times 0.35$ | V |
| | Voltage range applied to any | A port | | | 0 | 3.6 | |
| Vo | output in the high-impedance or power-off state | 1 2 V to 3 6 V | | 1.65 V to 5.5 V | 0 | 5.5 | V |
| | | A port inputs | 1.2 V to 3.6 V | 1.65 V to 5.5 V | | 40 | |
| Δt/Δν | Input transition rise or fall rate | D most insults | 1.2 V to 3.6 V | 1.65 V to 1.95 V | | 40 | ns/V |
| | idio | B port inputs | 1.2 V 10 3.6 V | 4.5 V to 5.5 V | | 30 | |
| T _A | Operating free-air temperature | Э | | | -40 | 85 | °C |

⁽¹⁾ The A and B sides of an unused data I/O pair must be held in the same state, i.e., both at V_{CCI} or both at GND.

(2) V_{CCA} must be less than or equal to V_{CCB} and must not exceed 3.6 V.
 (3) V_{CCI} is the supply voltage associated with the input port.



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Electrical Characteristics (1)(2)

over recommended operating free-air temperature range (unless otherwise noted)

| | PARAMETER | TEST | V | V | T, | _λ = 25°C | ; | -40°C to 8 | 85°C | UNIT |
|--------------------|-------------|---------------------------------|------------------|------------------|-----|---------------------|-----|------------------------|------|------|
| r | PARAIVIETER | CONDITIONS | V _{CCA} | V _{CCB} | MIN | TYP | MAX | MIN | MAX | UNII |
| V | | J 20 A | 1.2 V | | | 1.1 | | | | V |
| V_{OHA} | | $I_{OH} = -20 \mu A$ | 1.4 V to 3.6 V | | | | | V _{CCA} - 0.4 | | V |
| 1/ | | J 20 A | 1.2 V | | | 0.9 | | | | V |
| V_{OLA} | | I _{OL} = 20 μA | 1.4 V to 3.6 V | | | | | | 0.4 | V |
| V_{OHB} | | $I_{OH} = -20 \mu A$ | | 1.65 V to 5.5 V | | | | V _{CCB} - 0.4 | | V |
| V _{OLB} | | I _{OL} = 20 μA | | 1.65 V to 5.5 V | | | | | 0.4 | V |
| I _I | OE | $V_I = V_{CCI}$ or GND | 1.2 V to 3.6 V | 1.65 V to 5.5 V | | | ±1 | | ±2 | μΑ |
| | A port | V_1 or $V_0 = 0$ to 3.6 | 0 V | 0 V to 5.5 V | | | ±1 | | ±2 | |
| I _{off} | B port | V_{I} or $V_{O} = 0$ to 5.5 | 0 V to 3.6 V | 0 V | | | ±1 | | ±2 | μΑ |
| I _{OZ} | A or B port | OE = GND | 1.2 V to 3.6 V | 1.65 V to 5.5 V | | | ±1 | | ±2 | μΑ |
| | | | 1.2 V | 1.65 V to 5.5 V | | 0.06 | | | | |
| | | $V_I = V_{CCI}$ or GND, | 1.4 V to 3.6 V | 1.65 V to 5.5 V | | | | | 3 | ^ |
| I _{CCA} | | $I_{O} = 0$ | 3.6 V | 0 V | | | | | 2 | μΑ |
| | | | 0 V | 5.5 V | | | | | -2 | |
| | | | 1.2 V | 1.65 V to 5.5 V | | 3.4 | | | | |
| | | $V_I = V_{CCI}$ or GND, | 1.4 V to 3.6 V | 1.65 V to 5.5 V | | | | | 5 | |
| I _{CCB} | | $I_{O} = 0$ | 3.6 V | 0 V | | | | | -2 | μΑ |
| | | | 0 V | 5.5 V | | | | | 2 | |
| | | $V_I = V_{CCI}$ or GND, | 1.2 V | 1.65 V to 5.5 V | | 3.5 | | | | |
| I _{CCA} + | CCB | $I_{O} = 0$ | 1.4 V to 3.6 V | 1.65 V to 5.5 V | | | | | 8 | μΑ |
| | | $V_I = V_{CCI}$ or GND, | 1.2 V | 1.65 V to 5.5 V | | 0.05 | | | | |
| I _{CCZA} | | I _O = 0, OE = GND | 1.4 V to 3.6 V | 1.65 V to 5.5 V | | | | | 3 | μA |
| | | $V_I = V_{CCI}$ or GND, | 1.2 V | 1.65 V to 5.5 V | | 3.3 | | | | |
| I _{CCZB} | | I _O = 0, OE = GND | 1.4 V to 3.6 V | 1.65 V to 5.5 V | | | | | 5 | μA |
| C_{i} | OE | | 1.2 V to 3.6 V | 1.65 V to 5.5 V | | 2.5 | | | 3 | pF |
| C _{io} | A port | | 1.2 V to 3.6 V | 1.65 V to 5.5 V | | 5 | | | 6 | pF |
| o _{io} | B port | | 1.2 V 10 3.0 V | 1.00 V 10 0.0 V | | 11 | | | 14 | þΓ |

Timing Requirements

 $T_A = 25^{\circ}C$, $V_{CCA} = 1.2 \text{ V}$

| | | | V _{CCB} = 1.8 V | V _{CCB} = 2.5 V | V _{CCB} = 3.3 V | V _{CCB} = 5 V | UNIT |
|----------------|----------------|-------------|--------------------------|--------------------------|--------------------------|------------------------|------|
| | | | TYP | TYP | TYP | TYP | OMIT |
| | Data rate | | 20 | 20 | 20 | 20 | Mbps |
| t _w | Pulse duration | Data inputs | 50 | 50 | 50 | 50 | ns |

Timing Requirements

over recommended operating free-air temperature range, V_{CCA} = 1.5 V \pm 0.1 V (unless otherwise noted)

| | V _{CCB} = 1.8 V ± 0.15 V | | V _{CCB} = 2.5 V ± 0.2 V | | V _{CCB} = 3.3 V ± 0.3 V | | V _{CCB} = 5 V ± 0.5 V | | UNIT |
|-----------|--------------------------------------|-----|-------------------------------------|-----|-------------------------------------|-----|-----------------------------------|-----|------|
| | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| Data rate | | 40 | | 40 | | 40 | | 40 | Mbps |

⁽¹⁾ V_{CCI} is the supply voltage associated with the input port. (2) V_{CCO} is the supply voltage associated with the output port.



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Timing Requirements (continued)

over recommended operating free-air temperature range, V_{CCA} = 1.5 V \pm 0.1 V (unless otherwise noted)

| | | | | $V_{CCB} = 1.8 \text{ V} $ $V_{CCB} = 2.5 \text{ V} $ $\pm 0.15 \text{ V} $ | | | $V_{CCB} = 3.3 V$ $\pm 0.3 V$ | | V _{CCB} = 5 V ± 0.5 V | | UNIT |
|----------------|----------------|-------------|-----|---|-----|-----|----------------------------------|-----|-----------------------------------|-----|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t _w | Pulse duration | Data inputs | 25 | | 25 | | 25 | | 25 | | ns |

Timing Requirements

over recommended operating free-air temperature range, V_{CCA} = 1.8 V \pm 0.15 V (unless otherwise noted)

| | | V _{CCB} = 1.8 V ± 0.15 V | | V _{CCB} = 2.5 V ± 0.2 V | | V _{CCB} = 3.3 V ± 0.3 V | | V _{CCB} = 5 V ± 0.5 V | | UNIT | |
|----------------|----------------|--------------------------------------|-----|-------------------------------------|-----|-------------------------------------|-----|-----------------------------------|-----|------|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | Data rate | | | 60 | | 60 | | 60 | | 60 | Mbps |
| t _w | Pulse duration | Data inputs | 17 | | 17 | | 17 | | 17 | | ns |

Timing Requirements

over recommended operating free-air temperature range, V_{CCA} = 2.5 V \pm 0.2 V (unless otherwise noted)

| | | | V _{CCB} = 2 ± 0.2 | | V _{CCB} = 3 ± 0.3 | | | V_{CCB} = 5 V \pm 0.5 V | |
|----------------|----------------|-------------|-------------------------------|-----|-------------------------------|-----|-----|-----------------------------|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | |
| | Data rate | | | 100 | | 100 | | 100 | Mbps |
| t _w | Pulse duration | Data inputs | 10 | | 10 | | 10 | | ns |

Timing Requirements

over recommended operating free-air temperature range, V_{CCA} = 3.3 V \pm 0.3 V (unless otherwise noted)

| | | | V _{CCB} = 3 ± 0.3 | $V_{CCB} = 3.3 \text{ V} $ $V_{CCB} = 5 \text{ V} $ $\pm 0.5 \text{ V} $ | | 5 V V | UNIT |
|----------------|----------------|-------------|-------------------------------|--|----|----------|------|
| | | | MIN MAX MIN MAX | | | | |
| | Data rate | | | 100 | | 100 | Mbps |
| t _w | Pulse duration | Data inputs | 10 | | 10 | | ns |

Switching Characteristics

 $T_A = 25^{\circ}C$, $V_{CCA} = 1.2 \text{ V}$

| PARAMETER | FROM | то | V _{CCB} = 1.8 V | V _{CCB} = 2.5 V | V _{CCB} = 3.3 V | V _{CCB} = 5 V | UNIT |
|--------------------|--------------------|------------|--------------------------|--------------------------|--------------------------|------------------------|------|
| PARAMETER | (INPUT) | (OUTPUT) | TYP | TYP | TYP | TYP | UNII |
| | А | В | 6.9 | 5.7 | 5.3 | 5.5 | |
| t _{pd} | В | Α | 7.4 | 6.4 | 6 | 5.8 | ns |
| | 05 | Α | 1 | 1 | 1 | 1 | _ |
| t _{en} | t _{en} OE | В | 1 | 1 | 1 | 1 | μs |
| | | Α | 18 | 15 | 14 | 14 | 20 |
| t _{dis} | OE | В | 20 | 17 | 16 | 16 | ns |
| t _{rA} | A port | rise time | 4.2 | 4.2 | 4.2 | 4.2 | ns |
| t _{fA} | A port f | all times | 4.2 | 4.2 | 4.2 | 4.2 | ns |
| t _{rB} | B port r | ise times | 2.1 | 1.5 | 1.2 | 1.1 | ns |
| t _{fB} | B port fall times | | 2.1 | 1.5 | 1.2 | 1.1 | ns |
| t _{sk(o)} | Channel- | to-channel | 0.5 | 0.5 | 0.5 | 1.4 | ns |
| Max data rate | | | 20 | 20 | 20 | 20 | Mbps |



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Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 1.5 V \pm 0.1 V (unless otherwise noted)

| PARAMETER | FROM | TO (OUTBUT) | V _{CCB} = 1.8 V ± 0.15 V | | V_{CCB} = 2.5 V \pm 0.2 V | | V_{CCB} = 3.3 V \pm 0.3 V | | V _{CCB} = 5 V ± 0.5 V | | UNIT |
|--------------------|--------------------|-------------|--------------------------------------|------|-------------------------------|------|-------------------------------|------|-----------------------------------|------|------|
| | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | A | | 1.4 | 12.9 | 1.2 | 10.1 | 1.1 | 10 | 0.8 | 9.9 | 20 |
| t _{pd} B | В | Α | 0.9 | 14.2 | 0.7 | 12 | 0.4 | 11.7 | 0.3 | 13.7 | ns |
| 4 | OE | Α | | 1 | | 1 | | 1 | | 1 | |
| t _{en} | OE | В | | 1 | | 1 | | 1 | | 1 | μs |
| | | Α | 5.9 | 31 | 5.7 | 25.9 | 5.6 | 23 | 5.7 | 22.4 | 20 |
| t _{dis} | OE | В | 5.4 | 30.3 | 4.9 | 22.8 | 4.8 | 20 | 4.9 | 19.5 | ns |
| t _{rA} | A port ri | se times | 1.4 | 5.1 | 1.4 | 5.1 | 1.4 | 5.1 | 1.4 | 5.1 | ns |
| t _{fA} | A port fa | all times | 1.4 | 5.1 | 1.4 | 5.1 | 1.4 | 5.1 | 1.4 | 5.1 | ns |
| t _{rB} | B port ri | se times | 0.9 | 4.5 | 0.6 | 3.2 | 0.5 | 2.8 | 0.4 | 2.7 | ns |
| t _{fB} | B port fa | all times | 0.9 | 4.5 | 0.6 | 3.2 | 0.5 | 2.8 | 0.4 | 2.7 | ns |
| t _{sk(o)} | Channel-to-channel | | | 0.5 | | 0.5 | | 0.5 | | 0.5 | ns |
| Max data rate | | | 40 | | 40 | | 40 | | 40 | | Mbps |

Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 1.8 V \pm 0.15 V (unless otherwise noted)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | | V _{CCB} = 1.8 V ± 0.15 V | | V _{CCB} = 2.5 V ± 0.2 V | | 3.3 V 3 V | V_{CCB} = 5 V \pm 0.5 V | | UNIT | |
|--------------------|---------------------|----------------|-----|--------------------------------------|-----|-------------------------------------|-----|--------------|-----------------------------|------|------|--|
| | (INPUT) | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | | |
| 4 | Α | В | 1.6 | 11 | 1.4 | 7.7 | 1.3 | 6.8 | 1.2 | 6.5 | | |
| t _{pd} | В | Α | 1.5 | 12 | 1.3 | 8.4 | 1 | 7.6 | 0.9 | 7.1 | ns | |
| | OF | Α | | 1 | | 1 | | 1 | | 1 | | |
| t _{en} | t _{en} OE | В | | 1 | | 1 | | 1 | | 1 | μs | |
| | t _{dis} OE | Α | 5.9 | 31 | 5.1 | 21.3 | 5 | 19.3 | 5 | 17.4 | | |
| t _{dis} | OE | В | 5.4 | 30.3 | 4.4 | 20.8 | 4.2 | 17.9 | 4.3 | 16.3 | ns | |
| t _{rA} | A port ri | se times | 1 | 4.2 | 1.1 | 4.1 | 1.1 | 4.1 | 1.1 | 4.1 | ns | |
| t _{fA} | A port fa | all times | 1 | 4.2 | 1.1 | 4.1 | 1.1 | 4.1 | 1.1 | 4.1 | ns | |
| t _{rB} | B port ri | se times | 0.9 | 4.5 | 0.6 | 3.2 | 0.5 | 2.8 | 0.4 | 2.7 | ns | |
| t _{fB} | B port fall times | | 0.9 | 4.5 | 0.6 | 3.2 | 0.5 | 2.8 | 0.4 | 2.7 | ns | |
| t _{sk(o)} | Channel-to-channel | | | 0.5 | | 0.5 | | 0.5 | | 0.5 | ns | |
| Max data rate | | | 60 | | 60 | | 60 | | 60 | | Mbps | |



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Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 2.5 V \pm 0.2 V (unless otherwise noted)

| PARAMETER | FROM | TO (OUTPUT) | V _{CCB} = ± 0.2 | | V _{CCB} = 3.3 V ± 0.3 V | | V _{CCB} = ± 0.5 | UNIT | |
|--------------------|-------------------|--------------------|-----------------------------|--------------|-------------------------------------|------|-----------------------------|------|------|
| | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | MIN | MAX | |
| | А | В | 1.1 | 6.3 | 1 | 5.2 | 0.9 | 4.7 | 20 |
| t _{pd} | В | Α | 1.2 | 6.6 | 1.1 | 5.1 | 0.9 | 4.4 | ns |
| | ٥٢ | Α | | 1 | | 1 | | 1 | |
| t _{en} | OE | В | | 1 | | 1 | | 1 | μs |
| | 0.5 | Α | 5.1 | 21.3 | 4.6 | 15.2 | 4.6 | 13.2 | |
| t _{dis} | OE | В | 4.4 | 4.4 20.8 3.8 | | 16 | 3.9 | 13.9 | ns |
| t _{rA} | A port ri | se times | 0.8 | 3 | 0.8 | 3 | 0.8 | 3 | ns |
| t _{fA} | A port f | all times | 0.8 | 3 | 0.8 | 3 | 0.8 | 3 | ns |
| t _{rB} | B port ri | se times | 0.7 | 3 | 0.5 | 2.8 | 0.4 | 2.7 | ns |
| t _{fB} | B port fall times | | 0.7 | 3 | 0.5 | 2.8 | 0.4 | 2.7 | ns |
| t _{sk(o)} | Channel- | Channel-to-channel | | 0.5 | | 0.5 | | 0.5 | ns |
| Max data rate | | | 100 | | 100 | | 100 | | Mbps |

Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 3.3 V \pm 0.3 V (unless otherwise noted)

| PARAMETER | FROM | TO | V _{CCB} = 3 ± 0.3 | | V _{CCB} = ± 0.5 | UNIT | |
|--------------------|-----------|-----------|--------------------------------------|------|--------------------------|------|------|
| | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | |
| | A | В | 0.9 | 4.7 | 0.8 | 4 | 20 |
| t _{pd} | В | A | 1 | 4.9 | 0.9 | 4.5 | ns |
| | OE | A | | 1 | | 1 | μs |
| t _{en} | OE | В | | 1 | | 1 | |
| | OE | A | 4.6 | 15.2 | 4.3 | 12.1 | 20 |
| t _{dis} | OE | В | 3.8 | 16 | 3.4 | 13.2 | ns |
| t _{rA} | A port ri | se times | 0.7 | 2.5 | 0.7 | 2.5 | ns |
| t _{fA} | A port fa | all times | 0.7 | 2.5 | 0.7 | 2.5 | ns |
| t _{rB} | B port ri | se times | 0.5 | 2.3 | 0.4 | 2.7 | ns |
| t _{fB} | B port fa | all times | 0.5 | 2.3 | 0.4 | 2.7 | ns |
| t _{sk(o)} | Channel-t | o-channel | | 0.5 | | 0.5 | ns |
| Max data rate | | | 100 | | 100 | | Mbps |



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Operating Characteristics

 $T_A = 25^{\circ}C$

| | | | | | | V_{CCA} | | | | |
|------------------|-----------------------------|---|-------|-----------------|-------|------------------|-------|-------|--------------------|------|
| | | | 1.2 V | 1.2 V | 1.5 V | 1.8 V | 2.5 V | 2.5 V | 3.3 V | |
| | | | | | | V _{CCB} | | | | |
| PARAMETER | | TEST CONDITIONS | 5 V | 5 V 1.8 V 1.8 V | | 1.8 V | 2.5 V | 5 V | 3.3 V to 5 V | UNIT |
| | | | TYP | TYP | TYP | TYP | TYP | TYP | TYP | |
| C | A port input, B port output | C = 0 f = 10 MHz | 7.8 | 8 | 8 | 7 | 7 | 8 | 8 | - |
| C_{pdA} | B port input, A port output | $C_L = 0, f = 10 \text{ MHz},$ $t_r = t_f = 1 \text{ ns},$ | 12 | 11 | 11 | 11 | 11 | 11 | 11 | |
| _ | A port input, B port output | $OE = V_{CCA}$ | 38.1 | 29 | 29 | 29 | 29 | 30 | 30 | |
| C _{pdB} | B port input, A port output | (outputs enabled) | 25.4 | 19 | 18 | 18 | 18 | 21 | 21 | |
| C | A port input, B port output | C = 0 f = 10 MHz | 0.01 | 0.01 | 0.01 | 0.01 | 0.01 | 0.01 | 0.01 | pF |
| C_{pdA} | B port input, A port output | $C_L = 0, f = 10 \text{ MHz},$ $t_r = t_f = 1 \text{ ns},$ | 0.01 | 0.01 | 0.01 | 0.01 | 0.01 | 0.01 | 0.01 | |
| C | A port input, B port output | OE = GND | 0.01 | 0.01 | 0.01 | 0.01 | 0.01 | 0.01 | 0.02 | |
| C_{pdB} | B port input, A port output | (outputs disabled) | 0.01 | 0.01 | 0.01 | 0.01 | 0.01 | 0.02 | 0.03 | |

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PRINCIPLES OF OPERATION

Applications

The TXB0102 can be used in level-translation applications for interfacing devices or systems operating at different interface voltages with one another.

Architecture

The TXB0102 architecture (see Figure 1) does not require a direction-control signal to control the direction of data flow from A to B or from B to A. In a dc state, the output drivers of the TXB0101 can maintain a high or low, but are designed to be weak, so that they can be overdriven by an external driver when data on the bus starts flowing the opposite direction.

The output one shots detect rising or falling edges on the A or B ports. During a rising edge, the one shot turns on the PMOS transistors (T1, T3) for a short duration, which speeds up the low-to-high transition. Similarly, during a falling edge, the one shot turns on the NMOS transistors (T2, T4) for a short duration, which speeds up the high-to-low transition. The typical output impedance during output transition is 70 Ω at V_{CCO} = 1.2 V to 1.8 V, 50 Ω at V_{CCO} = 1.8 V to 3.3 V, and 40 Ω at V_{CCO} = 3.3 V to 5 V.

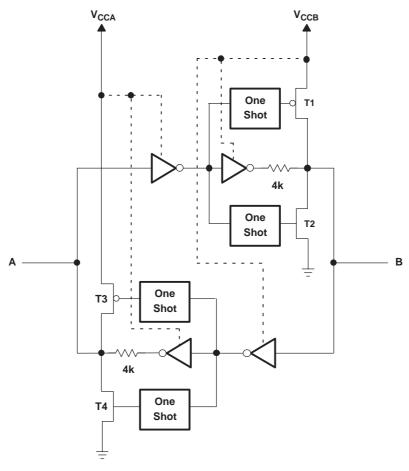


Figure 1. Architecture of TXB0102 I/O Cell

Input Driver Requirements

Typical I_{IN} vs V_{IN} characteristics of the TXB0102 are shown in Figure 2. For proper operation, the device driving the data I/Os of the TXB0102 must have drive strength of at least ± 2 mA.

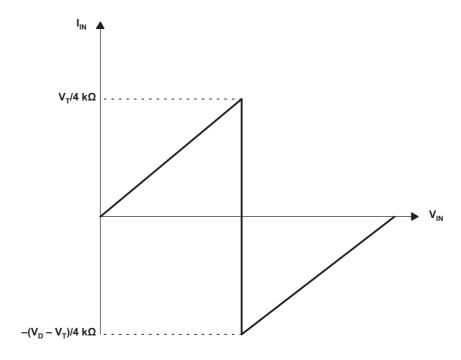
TXB0102

2-BIT BIDIRECTIONAL VOLTAGE-LEVEL TRANSLATOR WITH AUTO DIRECTION SENSING AND ±15-kV ESD PROTECTION



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PRINCIPLES OF OPERATION (continued)



- A. V_T is the input threshold voltage of the TXB0102 (typically $V_{CCI}/2$.
- B. V_D is the supply voltage of the external driver.

Figure 2. Typical I_{IN} vs V_{IN} Curve

Power Up

During operation, ensure that $V_{CCA} \le V_{CCB}$ at all times. During power-up sequencing, $V_{CCA} \ge V_{CCB}$ does not damage the device, so any power supply can be ramped up first. The TXB0102 has circuitry that disables all output ports when either V_{CC} is switched off $(V_{CCA/B} = 0 \text{ V})$.

Enable and Disable

The TXB0102 has an OE input that is used to disable the device by setting OE = low, which places all I/Os in the high-impedance (Hi-Z) state. The disable time (t_{dis}) indicates the delay between when OE goes low and when the outputs acutally get disabled (Hi-Z). The enable time (t_{en}) indicates the amount of time the user must allow for the one-shot circuitry to become operational after OE is taken high.

Pullup or Pulldown Resistors on I/O Lines

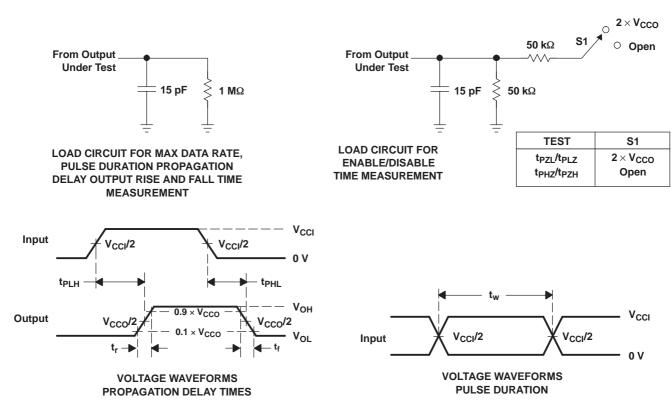
The TXB0102 is designed to drive capacitive loads of up to 70 pF. The output drivers of the TXB0102 have low dc drive strength. If pullup or pulldown resistors are connected externally to the data I/Os, their values must be kept higher than 50 k Ω to ensure that they do not contend with the output drivers of the TXB0102.

For the same reason, the TXB0102 should not be used in applications such as I²C or 1-Wire where an open-drain driver is connected on the bidirectional data I/O. For these applications, use a device from the TI TXS01xx series of level translators.



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PARAMETER MEASUREMENT INFORMATION



- A. C_L includes probe and jig capacitance.
- B. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_0 = 50 \Omega$, $dv/dt \geq$ 1 V/ns.
- C. The outputs are measured one at a time, with one transition per measurement.
- D. t_{PLH} and t_{PHL} are the same as t_{pd} .
- E. V_{CCI} is the V_{CC} associated with the input port.
- F. V_{CCO} is the V_{CC} associated with the output port.
- G. All parameters and waveforms are not applicable to all devices.

Figure 3. Load Circuits and Voltage Waveforms



PACKAGE OPTION ADDENDUM

25-Sep-2007

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|-----------------|--------------------|------|----------------|----------------------------|------------------|------------------------------|
| TXB0102DCUR | ACTIVE | US8 | DCU | 8 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TXB0102DCURG4 | ACTIVE | US8 | DCU | 8 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TXB0102DCUT | ACTIVE | US8 | DCU | 8 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TXB0102DCUTG4 | ACTIVE | US8 | DCU | 8 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TXB0102YZPR | ACTIVE | WCSP | YZP | 8 | 3000 | Green (RoHS & | SNAGCU | Level-1-260C-UNLIM |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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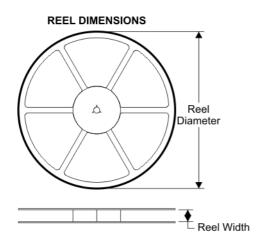
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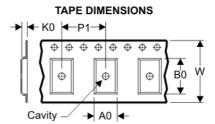




24-Sep-2007

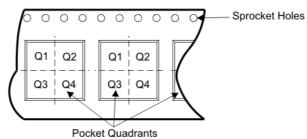
TAPE AND REEL BOX INFORMATION





| | Dimension designed to accommodate the component width |
|----|---|
| | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

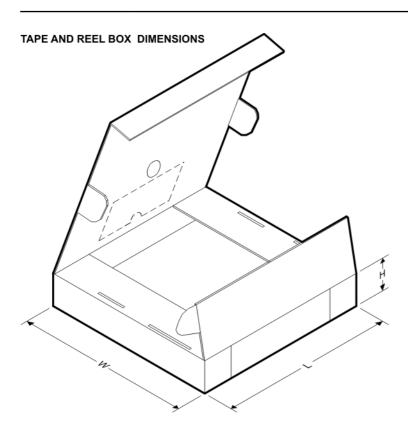


| Device | Package | Pins | Site | Reel Diameter (mm) | Reel Width (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|---------|------|---------|--------------------------|-----------------------|---------|---------|---------|------------|-----------|------------------|
| TXB0102YZPR | YZP | 8 | SITE 12 | 180 | 8 | 1.1 | 2.1 | 0.56 | 4 | 8 | Q1 |





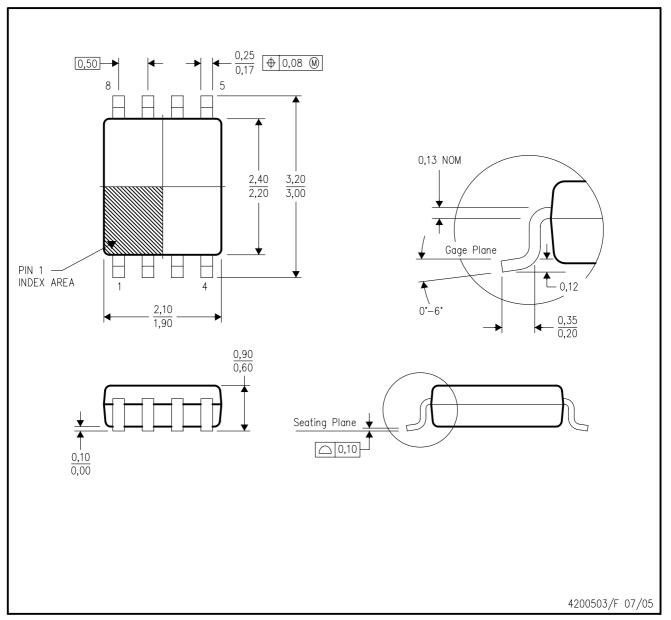
24-Sep-2007



| Device | Package | Pins | Site | Length (mm) | Width (mm) | Height (mm) |
|-------------|---------|------|---------|-------------|------------|-------------|
| TXB0102YZPR | YZP | 8 | SITE 12 | 220.0 | 220.0 | 0.0 |

DCU (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE (DIE DOWN)



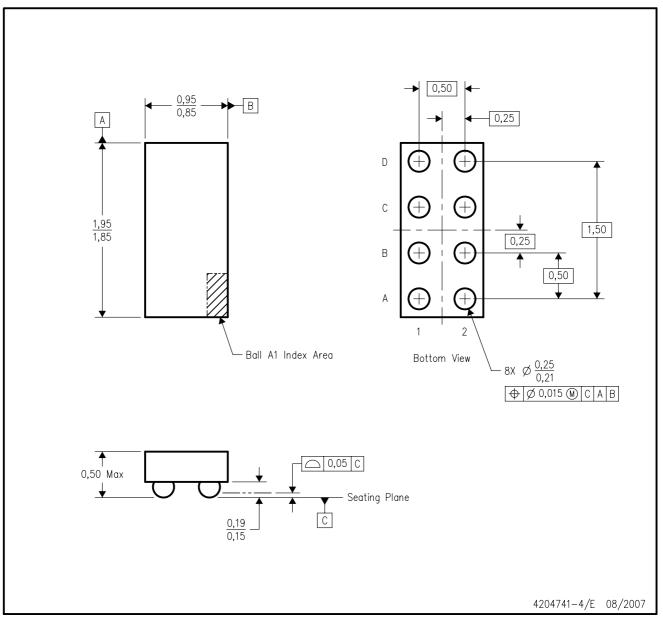
NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-187 variation CA.



YZP (R-XBGA-N8)

DIE-SIZE BALL GRID ARRAY



NOTES:

- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
- B. This drawing is subject to change without notice.
- C. NanoFree™ package configuration.
- D. This package is lead-free. Refer to the 8 YEP package (drawing 4204725) for tin-lead (SnPb).

NanoFree is a trademark of Texas Instruments.



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